

FEB 2 4 2004



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

HABA et al.

Serial No.:

09/888,642

Filed:

June 26, 2001

For:

ELECTRIC COPPER PLATING LIQUID AND PROCESS FOR

MANUFACTURING SEMICONDUCTOR INTEGRATED CIRCUIT

DEVICE USING SAME

Art Unit:

1753

Examiner:

E. Wong

PETITION FOR EXTENSION OF TIME

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

February 17, 2004

Sir:

In the matter of the above-identified application, Applicants hereby respectfully petition for an extension of time to permit filing a response within the first month subsequent to expiration of the shortened statutory period set in the outstanding Office Action mailed October 16, 2003. A credit card charge in the amount of \$110.00 to cover the required fee for the requested extension of time is attached hereto.

It is respectfully requested that any shortage in the fee be charged to the account of Antonelli, Terry, Stout & Kraus, LLP, Account No. 01-2135 (referencing Case No. 500.40269X00).

02/23/2004 MBERHE

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Respectfully submitted

William I. Solomon

Registration No. 28,565

ANTONELLI, TERRY, STOUT & KRAUS, LLP

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